

Gate Driver Module 2CG010BBC11N

Overview

Gate driver 2CG010BBC11N is a dual channel gate driver designed for IGBT and SiC MOSFET.

The high breakdown voltage and low parasitic capacitance make it suitable for gate drives such as SiC MOSFET and IGBT.

Features

- · Ideal for drive of IGBT and SiC MOSFET
- Gate voltage : +15V/-10V
- · ALL-IN-ONE (Built-in isolated DC / DC converter and gate drive circuit)
- · Low parasitic capacitance (about 12pF) ; highly resistant to common-mode noise.
- Fast response : about 100nsec(typ)
- The isolation for primary-secondary signal used fast response isolator.
- Input-to-Output dielectric withstand voltage : AC5000V
- Output CH1-to-Ouput CH2 dielectric withstand voltage : AC4000V
- Input-to-Output insulation distance : 14mm (clearance), 16mm(creepage) (As for Gate driver module PCB)
- Output CH1-to-Output CH2 insulation distance : 7mm (clearance), 12mm(creepage)
- DC/DC converter input voltage :13~28V
- Signal input voltage : 3.3V,5V
- Overload protection (DC/DC converter)
- Overheat protection (DC/DC converter)
- Half bridge mode (Gate drive circuit)
- Desaturation protection (Gate drive circuit)
- Soft turn-off function (Gate drive circuit)
- Fault signal output function (Gate drive circuit)
- Miller function (Gate drive circuit)
- Under-voltage lockout(UVLO) (Gate drive circuit)
- Insulating moistureproof coating
- Safety standards : UL508(file no.E243511) (DC/DC converter only)
- Reinforced isolation according to IEC 60664-1 (IEC61800-5-1, IEC62477-1, IEC62109-1, etc.)
- UL compliant (UL1741, UL508, etc.)

Application

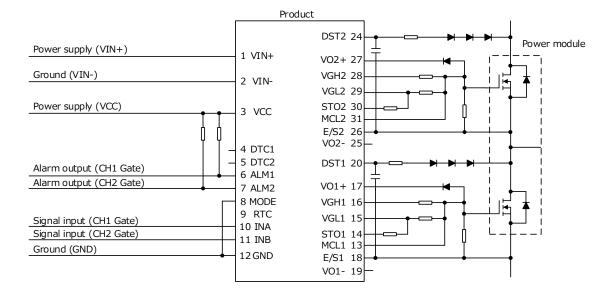
Industrial inverter, power conditioner, etc …

Module information

Part number	Output voltage	Miller clamp	Status
2CG010BBC11N	+15V/-10V	Yes	Active
2CG010BBC12N	+15V/-15V	Yes	Active
2CG010BBC13N	+18V/-4V	Yes	Active
2CG010BBC14N	+18V/-2V	Yes	Active



Circuit Image



Pin Connection

Input

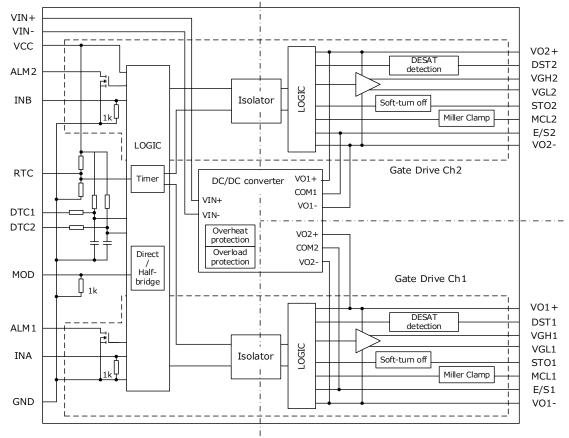
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Pin No.	Name	CH	Function
1	VIN+	Common	Power supply for DC/DC converter(+)
2	VIN-	Common	Power supply for DC/DC converter($-$)
3	VCC	-	Power supply for drive circuit
4	DTC1	1	Dead time adjustment
5	DTC2	2	Dead time adjustment
6	ALM1	1	Alarm signal output
7	ALM2	2	Alarm signal output
8	MOD	-	Mode select
9	RTC	-	Recovery time of protection circuit control
10	INA	1	Control input A
11	INB	2	Control input B
12	GND	-	Ground for drive circuit

Output Pin No. Name CH Function 13 MCL1 Miller clamp pin 1 14 ST01 1 Soft turn off pin 15 VGL1 1 Gate OFF side pin 16 VGH1 1 Gate ON side pin 17 V01+ 1 DC/DC converter output pin 18 E/S1 Emitter • source connection pin 1 19 V01-1 DC/DC converter output pin 20 DST1 1 Desaturation protection pin 21 NONE None -22 NONE -None 23 NONE None -24 DST2 2 Desaturation protection pin V02-25 2 DC/DC converter output pin 26 2 E/S2 Emitter · source connection pin 27 V02+ 2 DC/DC converter output pin VGH2 28 2 Gate ON side pin 29 VGL2 2 Gate OFF side pin 30 STO2 2 Soft turn off pin 31 MCL2 2 Miller clamp pin



2CG010BBC11N Datasheet

Internal Block Diagram



■I/O Condition Table

No.	Status				Inp	out					Out	:put(C	H2)			Out	:put(C	H1)	
NO.	Status	VO+	DST2	DST1	MCL2	MCL1	MOD	INB	INA	ALM2	VGH2	VGL2	STO2	MCL2	ALM1	VGH1	VGL1	ST01	MCL1
1	VOx+ UVLO	UVLO	Х	Х	Х	Х	Х	Х	Х	L	Hi-Z	Hi-Z	L	L	L	Hi-Z	Hi-Z	L	L
2	ES-VOx- short	Х	Х	Х	Х	Х	Х	Х	Х	L	Hi-Z	SD	SD	SD	L	Hi-Z	SD	SD	SD
3		0	-	L	-	Н	L	-	L	-	-	-	-	-	Hi-Z	Hi-Z	L	L	Hi-Z
4	Normal	0	-	L	-	L	L	-	L	-	-	-	-	-	Hi-Z	Hi-Z	L	L	L
5	operation	0	-	L	-	Н	L	-	Н	-	-	I	-	-	Hi-Z	Н	Hi-Z	Hi-Z	Hi-Z
6	(Direct	0	L	-	Н	-	L	L	-	Hi-Z	Hi-Z	L	L	Hi-Z	-	-	-	-	-
7	Mode)	0	L	-	L	-	L	L	-	Hi-Z	Hi-Z	L	L	L	-	-	-	-	-
8		0	L	-	Н	-	L	Н	-	Hi-Z	Н	Hi-Z	Hi-Z	Hi-Z	-	-	-	-	-
9	Normal operation	0	L	L	L	L	Н	L	Х	Hi-Z	Hi-Z	L	L	L	Hi-Z	Hi-Z	L	L	L
10	(Half-bridge	0	L	L	Н	L	Н	Н	L	Hi-Z	Н	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	L	L	L
11	Mode)	0	L	L	L	Н	Н	Н	Н	Hi-Z	Hi-Z	L	L	L	Hi-Z	Н	Hi-Z	Hi-Z	Hi-Z
12		0	-	Hi-Z	-	L	L	-	L	-	-	-	-	-	Hi-Z	Hi-Z	L	L	L
13	Desaturation	0	-	Hi-Z	-	Н	L	-	Н	-	-	I	-	-	L	Hi-Z	Hi-Z	L	Hi-Z
14	protection1	0	-	Hi-Z	-	L	Н	Н	L	-	-	I	-	-	Hi-Z	Hi-Z	L	L	L
15		0	-	Hi-Z	-	Н	Н	Н	Н	-	-	I	-	-	L	Hi-Z	Hi-Z	L	Hi-Z
16		0	Hi-Z	-	L	-	L	L	-	Hi-Z	Hi-Z	L	L	L	-	-	-	-	-
17	Desaturation	0	Hi-Z	-	Н	-	L	Н	-	L	Hi-Z	Hi-Z	L	Hi-Z	-	-	-	-	-
18	protection2	0	Hi-Z	-	L	-	Н	Н	Н	Hi-Z	Hi-Z	L	L	L	-	-	-	-	-
19		0	Hi-Z	-	Н	-	Н	Н	L	L	Hi-Z	Hi-Z	L	Hi-Z	-	-	-	-	-

 \bigcirc : Vox+ UVLO > UVLO, X : Don't care, SD : Shut down



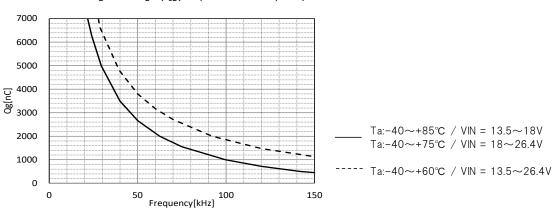
Absolute Maximum Ratings

Item		Symbol	Min	Max	Unit	Conditions · Note
Input voltage for DC/DC co	onverter	$V_{\rm IN}$	-0.3	28	Vdc	Between VIN+ to VIN-
Input-side signal voltage		$V_{CC,}V_{SG}$	-0.3	5.5	V	VCC, RTC, MOD, INA, INB
Input side signal voltage		V _{ALM}	-0.3	28	V	ALM1, ALM2
Input-side signal maximun	n current	I_{ALM}	-	5	mA	ALM1, ALM2
DESAT pin input voltage		V_{DESAT}	-0.3	V _{GH} +0.3	V	
Miller clamp pin input voltage		V_{CLAMP}	V_{GL} -0.3	V _{GH} +0.3	V	
Maximum gate current	Maximum gate current		-	43	Α	
DC/DC converter output pe	ower	P _{OUT}	-	4	W	Per output circuit
Switching frequency		F _{sw}	-	150	kHz	See the permissible frequency curve
Operating temperature range	$V_{IN} = 13.5 - 18V$	T _{OP}	-40	85	°C	See the permissible frequency curve
operating temperature range	$V_{IN} = 18-26.4V$	T _{OP}	-40	75	°C	
Operating humidity		RH _{OP}	20	95	%RH	No condensation
Storage temperature range		T _{STG}	-40	90	°C	
Storage humidity		RH _{STG}	5	95	%RH	No condensation

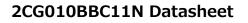
■ Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions · Note
Input voltage range for DC/DC converter	V_{IN}	13.5	26.4	Vdc	
Input-side signal voltage range	$V_{\text{CC},}V_{\text{SG}}$	3	5.5	Vdc	
Driver circuit number	N	-	2	-	
Logic high level input voltage	V_{SGH}	V _{CC} x0.7	-	V	MOD, INA, INB
Logic low level input voltage	V _{SGL}	-	V _{CC} x0.3	V	MOD, INA, INB
Source current of control signal	I _{SG}	5	-	mA	MOD, INA, INB V _{SG} =5V
Maximum gate drive capability (150 kHz)	Q _{MAX}	-	160	nC	Gate current (ave) = 24mA Reference value
Maximum gate drive capability (30 kHz)	Q _{MAX}	-	4900	nC	Gate current (ave) = 147mA Reference value
Maximum gate charge amount	Q _G	-	7000	nC	
Minimum input pulse width	t _{INMSK}	60	-	ns	

■ Permissible frequency curve



Total gate charge (Qg) vs permissible frequency curve





Electrical Sp	ecification (Vi	n=24V,	Vcc=5V	.Ta=25°	°C, Unles	s othe	rwise specified)
	Item	Symbol	Min	Тур	Max	Unit	Conditions · Note
DC/DC conve	rter	-					-
Start-up volta	ige	V _{START}	-	-	13	V	
Input current		I _{IN}	-	0.42	-	А	Fsw=22kHz / Test load: 280nF
Standby powe	er	P _{STBY}	-	1.2	-	W	No load
Logic inputs		-			-		-
Logic high lev	el input voltage	V_{SGH}	$V_{CC} ext{ x0.7}$	-	-	V	MOD, INA, INB / Guaranteed by design
Logic low leve	el input voltage	V _{SGL}	-	-	V _{CC} x0.3	V	MOD, INA, INB / Guaranteed by design
Logic pull-dov	vn resistance	R _{SGD}	-	1000	-	Ω	MOD, INA, INB
Gate driver ou	utput	-			-		-
Gate ON side pi	n / output voltage(+)	V_{GH}, V_{O+}	14	15	16	V	No load
Gate OFF side p	in / output voltage(-)	V_{GL}, V_{O-}	-11	-10	-9	V	No load
Miller clamp v	roltage	V_{CLAMP}	-	1.2	-	V	I_{CLAMP} =500mA, Guaranteed by design
Miller clamp O	N threshold voltage	V _{CLPON}	-	V_{GL} +2	-	V	
Delay time	Turn ON time	t _{PON}	-	100	-	ns	
Delay time	Turn OFF time	t _{POFF}	-	100	-	ns	
Dead time		t _{DEAD}	-	4.1	-	us	Half bridge mode

■ Electrical Specification (Vin=24V, Vcc=5V.Ta=25°C, Unless otherwise specified)

Protection

Item	Symbol	Min	Тур	Max	Unit	Conditions · Note
DC/DC converter						•
Overload protection	-	10.5	-	-	W	Auto recovery
Overheat protection	-	120	-	150	°C	Auto recovery, Internal temperature
Gate driver						•
Output voltage(H) UVLO OFF voltage	V _{UVLOGHH}	13.2	13.5	13.8	V	Guaranteed by design
Output voltage(H) UVLO ON voltage	V_{UVLOGHL}	12.2	12.5	12.8	V	Guaranteed by design
DESAT charge current	I _{DESAT}	200	240	280	uA	Guaranteed by design
DESAT detection voltage	V _{DESAT}	6.0	6.35	7.0	V	Guaranteed by design
DESAT detection filter time	t _{DSTFIL}	-	400	-	ns	DSTxpin open
DESAT detection time	t _{DSTOUT}	-	450	-	ns	DSTxpin open
Alarm signal output L voltage	V _{ALML}	-	-	0.5	V	I _{ALM} =5mA
Alarm signal output time	t _{ALM}	-	650	-	ns	
Restart time	$t_{RESTART}$	-	110	-	ms	
Soft turn off duration	t _{sto}	-	4	-	us	



Insulation

Item	Specification	Conditions · Note
Between Input-Output		
Dielectric withstand voltage	AC5000V	1min, Cutoff 2mA
Insulation resistance	100MΩ or more	DC500V
Partial discharge extinction volt.	1768Vpeak or more	According to EN50178/IEC 60270
Common-mode transient immunity (CMTI)	70kV/us	
Minimum clearance distances	14mm	
Minimum creepage distances	16mm	As for Gate driver module PCB
Between CH1-CH2		• •
Dielectric withstand voltage	AC4000V	1min, Cutoff 2mA
Insulation resistance	100MΩ or more	DC500V
Partial discharge extinction volt.	1700Vpeak or more	According to EN50178/IEC 60270
Minimum clearance distances	7mm	
Minimum creepage distances	12mm	As for Gate driver module PCB

Storage Conditions

Item	Min	Max	Unit	Conditions • Note
Storage temperature	-25	60	ĉ	A packing state

%If you want to use past the long period there is a concern that the solder non-wetting by terminal oxidation to occur. Therefore, please use from taking enough tests.

■ Recommended Soldering Condition

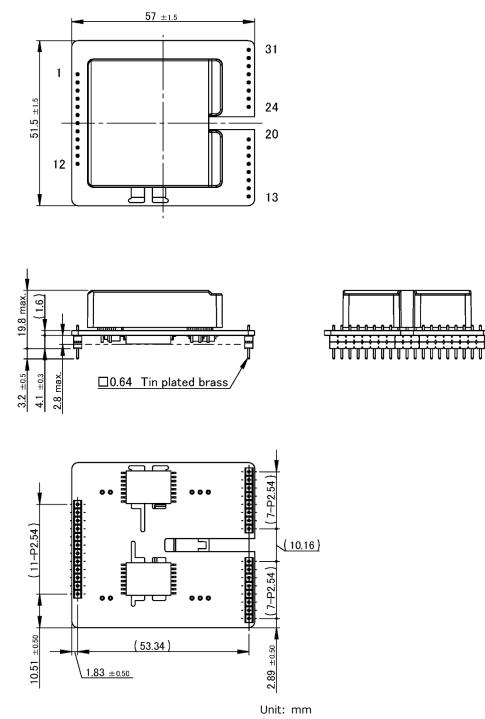
: 255±3℃ Less than 3sec
Temperature of preheating $110^\circ C \sim 130^\circ C$
End temperature of preheating 110℃±10℃
: 360℃(MAX) Less than 3sec

Usage Cautions

- Always mount fuse on the plus side of input for ensuring safety because the fuse is not built-in the product.
 Please select the fuse considering conditions such as steady current, inrush current, and ambient temperature.
 When using a fuse having large rated current or high capacity input electrolytic condenser, by combining another converter and input line and input electrolytic condenser, fuse may not blow off in the case of abnormality.
 Do not combine high voltage line and fuse.
- Make sure the rise/fall time of the input signal is 500ns or less.
- This product has DESAT protection for arm short circuit and load short circuit protection.
 However, even if this protection works, the IGBT may be damaged if abnormally high current occurs due to IGBT's characteristics variations or the load short-circuit mode during parallel operation.
 To ensure safety, be sure to check the short-circuit current at the unit in which this product is integrated, and evaluate whether it can protect under the condition that there is no damage to the IGBT.
- The coating material is applied to the product, so it may appear to be partially whitened. This does not affect the characteristics of the product.



Outline Dimensional Drawing



Note: 1. The dimensional tolerance without directions is \pm 0.5mm.

Product Weight

45.0g(typ)





Important Notice

- This information and product are subject to change without prior notice for the purpose of improvements, etc. Ensure that you are in possession of the most up-to-date information when using this product.
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 - where the product will be exposed to such liquids.
 - Use that involves exposure to direct sunlight, outdoor exposure, or dusty conditions.
 - Use in locations where corrosive gases such as salt air, C12, H2S, NH3, SO2, or NO2, are present.
 - Use in environments with strong static electricity or electromagnetic radiation.
 - Use that involves placing inflammable material next to the product.
 - Use of this product either sealed with a resin filling or coated with resin.
 - Use of water or a water soluble detergent for flux cleaning.
 - Use in locations where condensation is liable to occur.
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